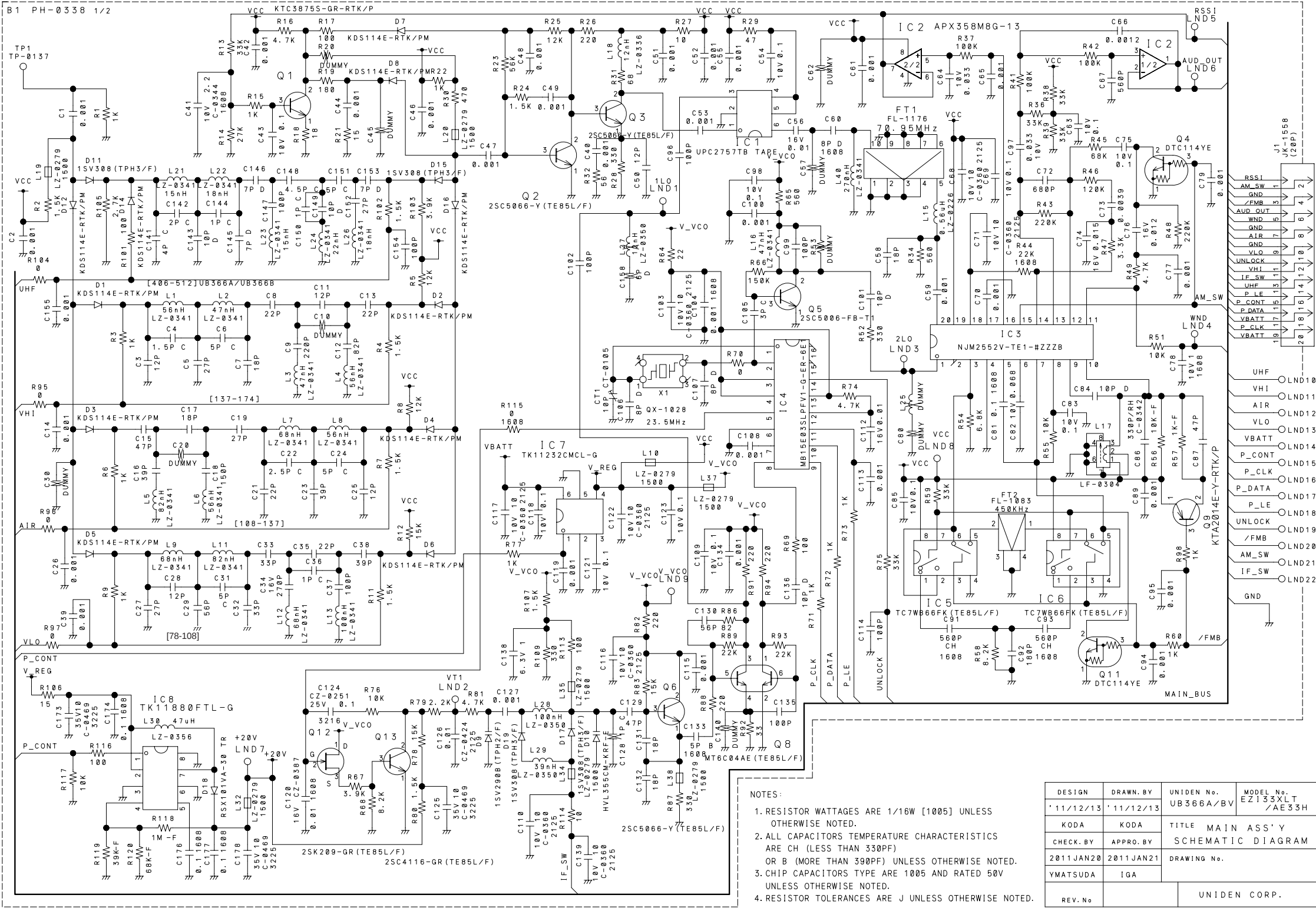


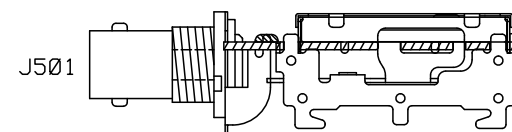
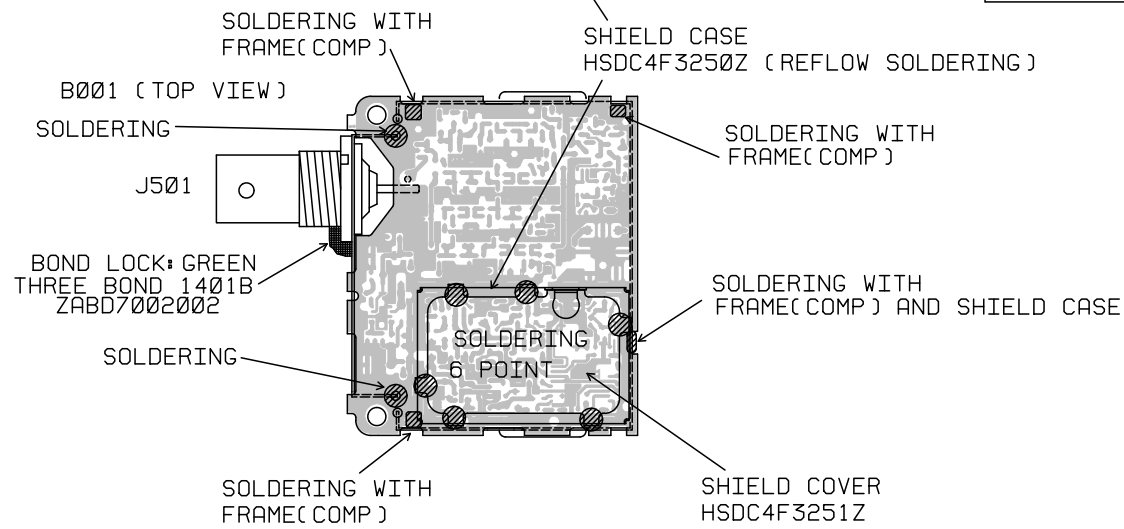
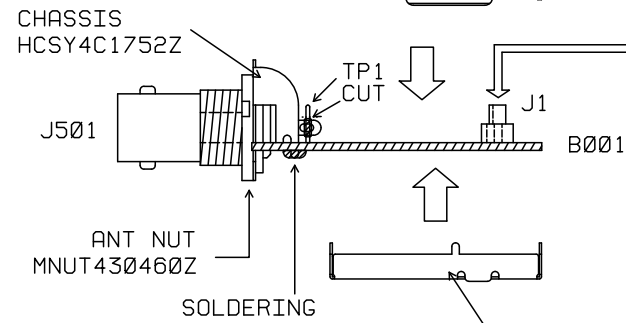
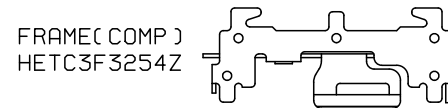
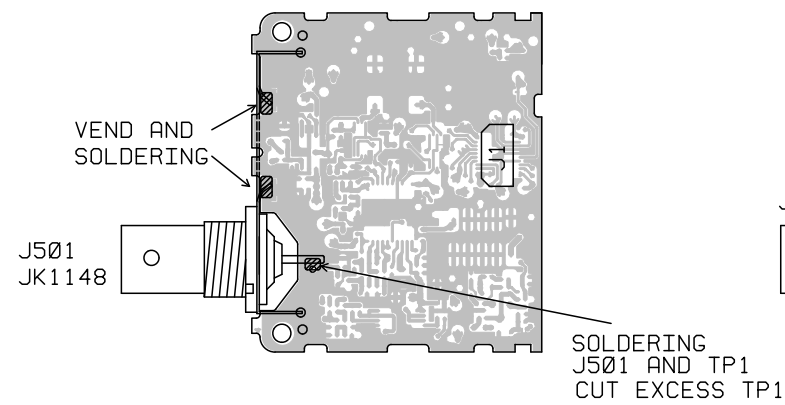


- NOTES:
1. RESISTOR WATTAGES ARE 1/16W [1005] UNLESS OTHERWISE NOTED.
 2. ALL CAPACITORS TEMPERATURE CHARACTERISTICS ARE CH (LESS THAN 330PF) OR B (MORE THAN 330PF) UNLESS OTHERWISE NOTED.
 3. CHIP CAPACITORS TYPE ARE 1005 AND RATED 50V UNLESS OTHERWISE NOTED.
 4. RESISTOR TOLERANCES ARE J UNLESS OTHERWISE NOTED.

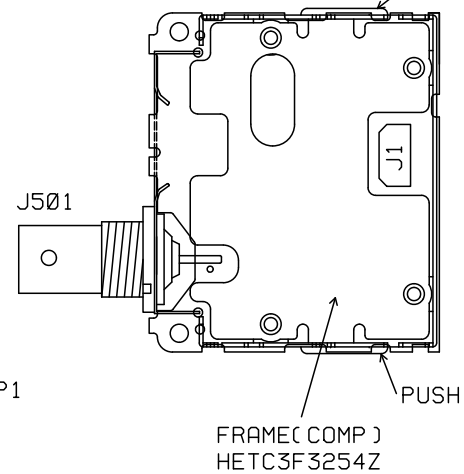
DESIGN	DRAWN. BY	UNIDEN No.	MODEL No.
' 11/12/13	' 11/12/13	UB366A/BV	EZ133XLT /AE33H
KODA	KODA	TITLE MAIN ASS'Y SCHEMATIC DIAGRAM	
CHECK. BY	APPRO. BY		
2011JAN20	2011JAN21	DRAWING No.	
YMATSUDA	IGA		
REV. No		UNIDEN CORP.	

Use Pb free Solder

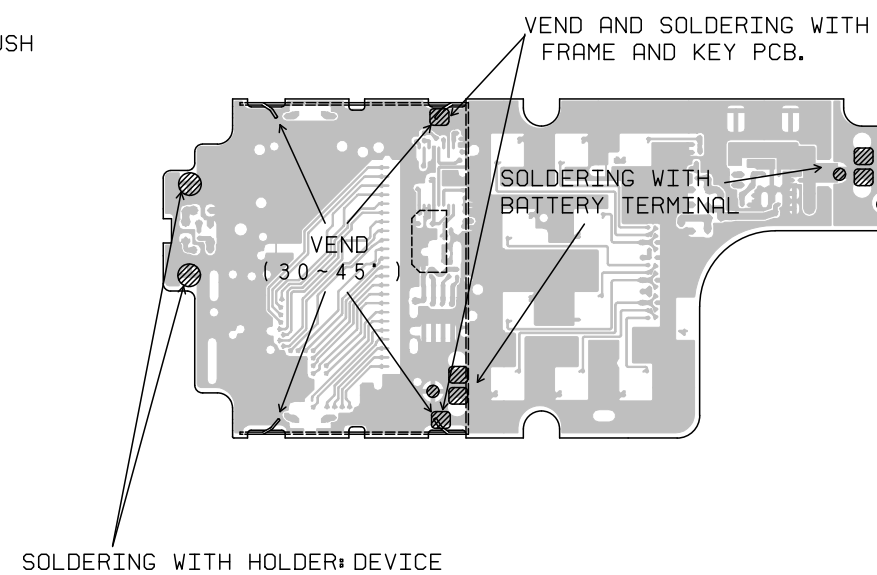
B001 PH-338 1/2 MAIN PCB
(BOTTOM VIEW)



B001
(BOTTOM VIEW)



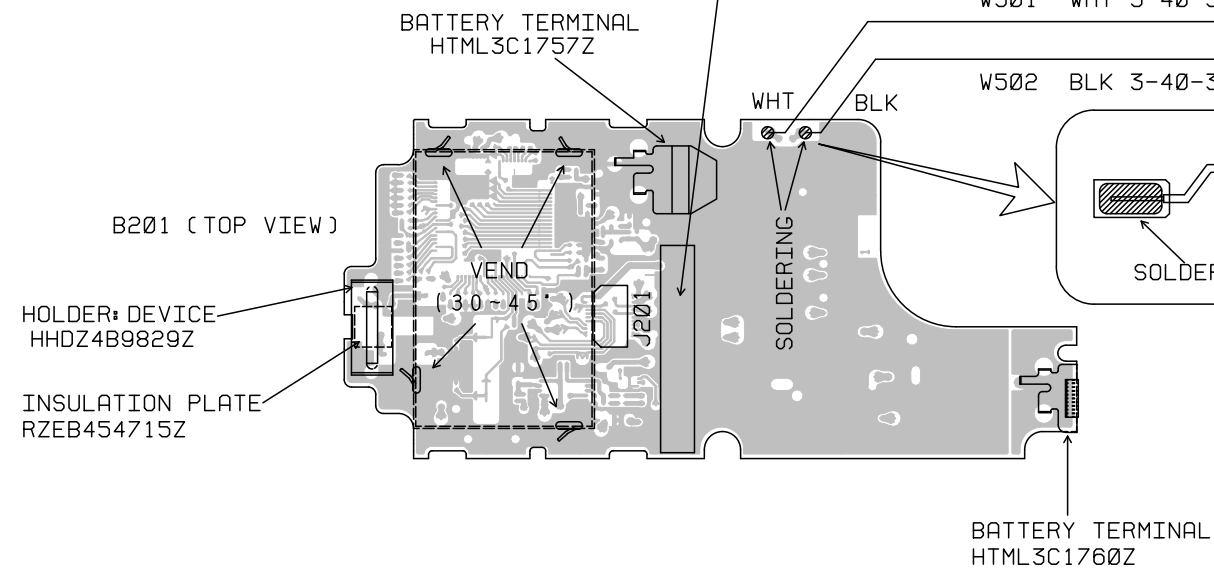
B201 PH-338 2/2 KEY PCB
(BOTTOM VIEW)



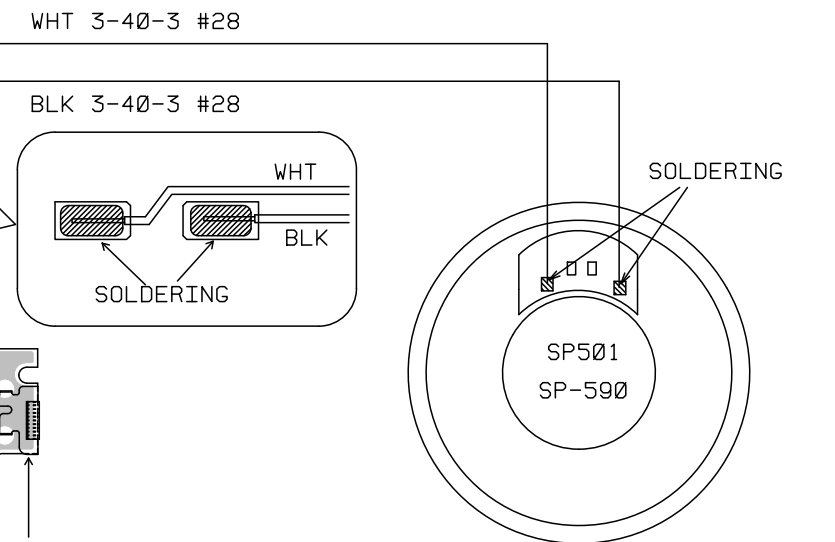
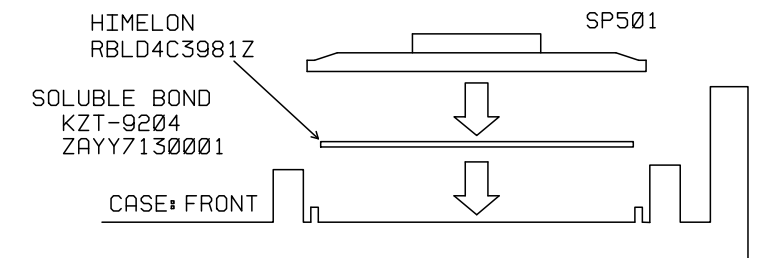
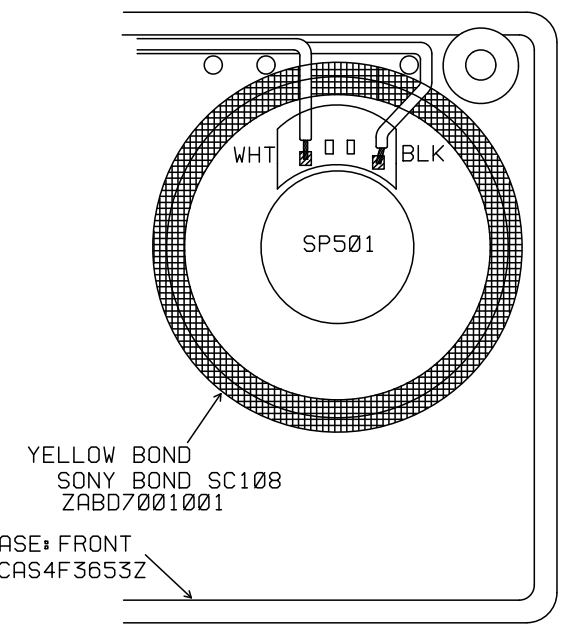
LCD ASS'Y

CONNECT J201 TO J1

INSULATION PLATE
RZEB4C1831Z



WIRES FITTING

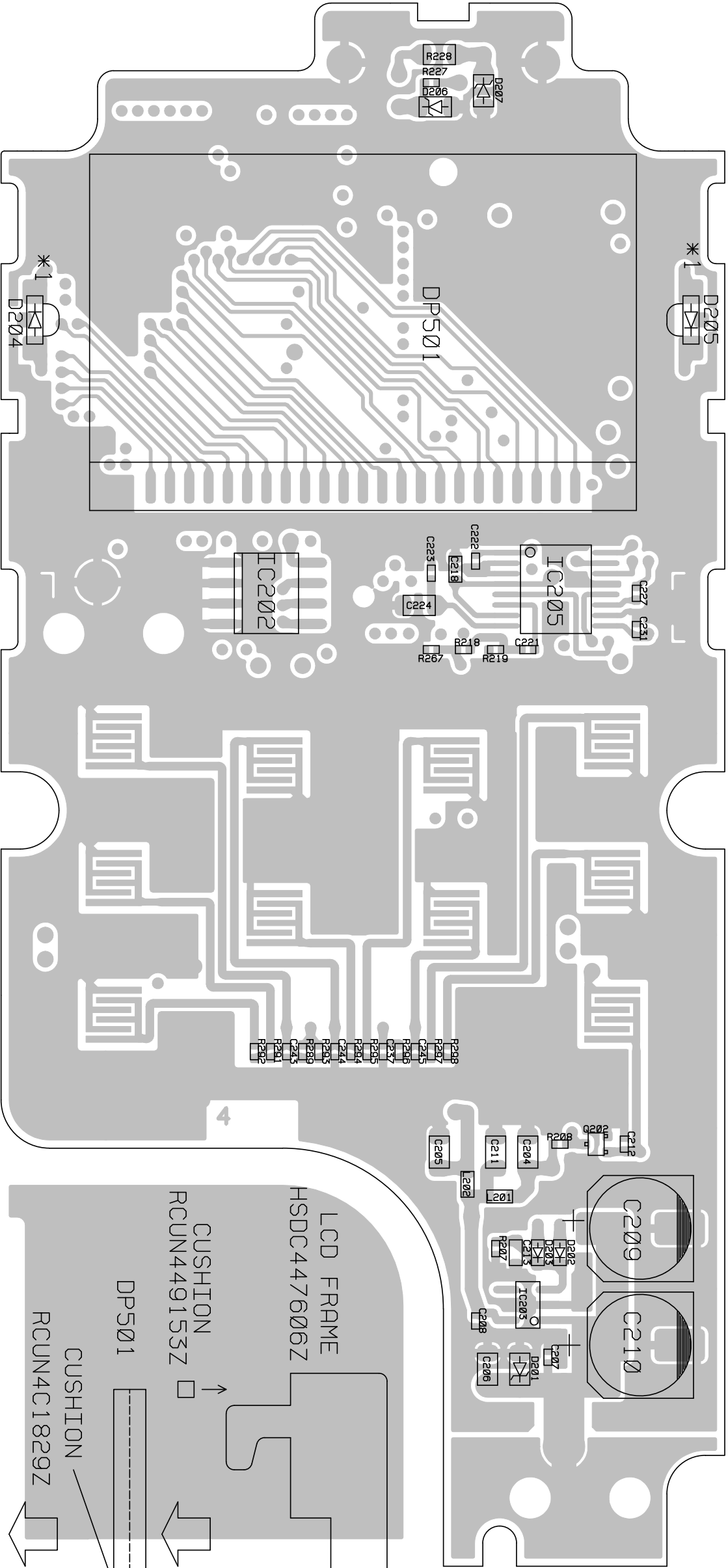


1. CHASSIS WITH ANTENNA JACK INSTALL TO MAIN PCB, THEN VEND AND SOLDER.
2. HOLDER PCB INSTALL TO MAIN PCB, THEN VEND AND SOLDER.
3. SHIELD CASES INSTALL TO MAIN PCB, THEN SOLDER.
4. SHIELD PLATE INSTALL TO HOLDER PCB, THEN SOLDER.
5. KEY PCB ASS'Y INSTALL TO MAIN PCB ASS'Y, THEN VEND AND SOLDER.
(J201 CONNECT TO J1)

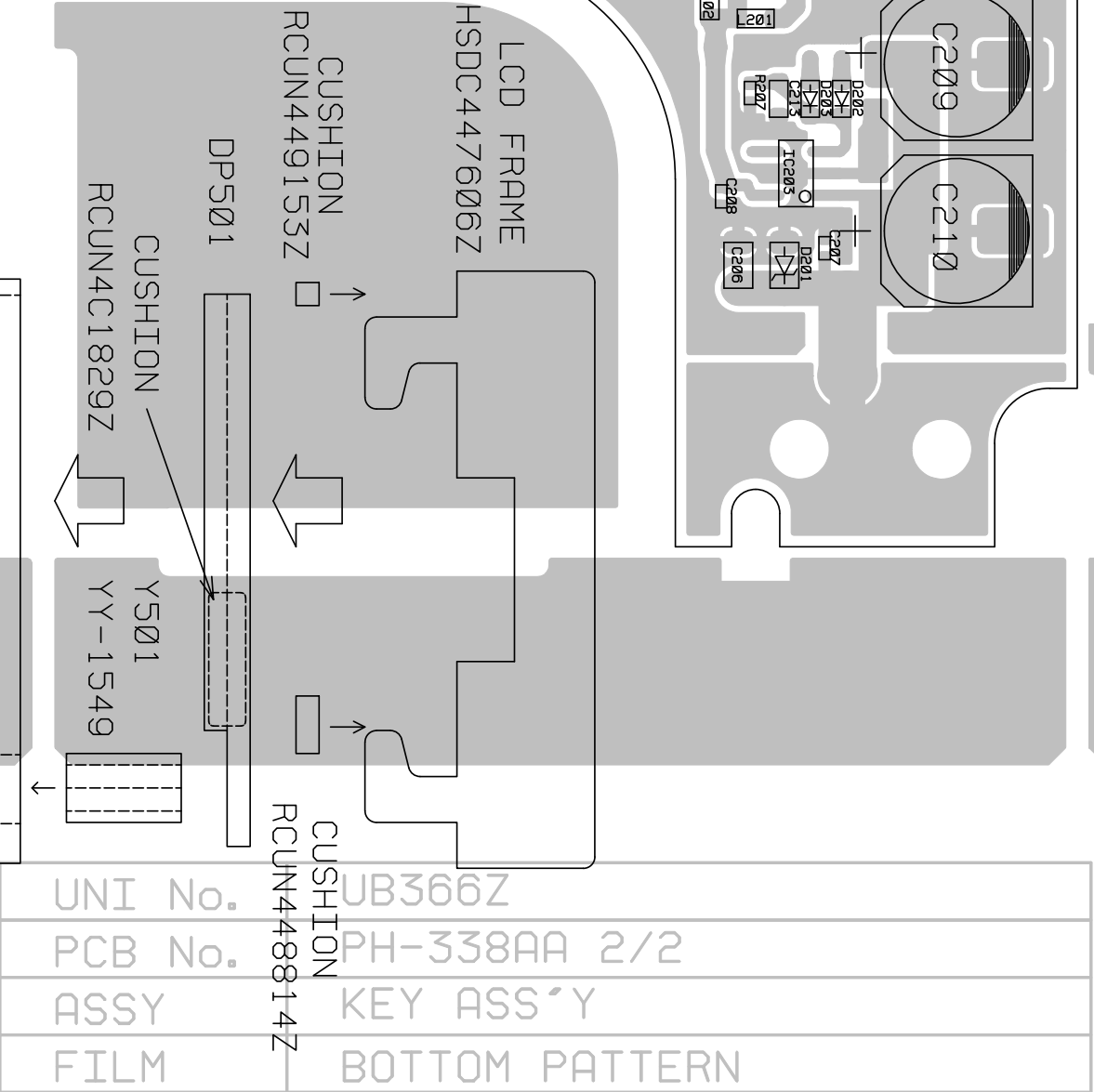
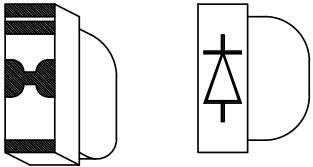
DESIGN. BY	DRAWN. BY	UNIDEN NO.	MODEL NO.
2011JAN20	2011JAN20	UB366Z	EZI30XLT
KODA	KODA	TITLE	
CHECK. BY	APPRO. BY	WIRING DIAGRAM	
2011JAN21	2011JAN21	DRAWING NO.	
Shimada	IGA	E33-5782	
REV. NO.		UNIDEN CORP.	

Use Pb free Solder

B201 PH-338AA 2/2 (BOTTOM VIEW)



*1: D204/D205 LED DIRECTION



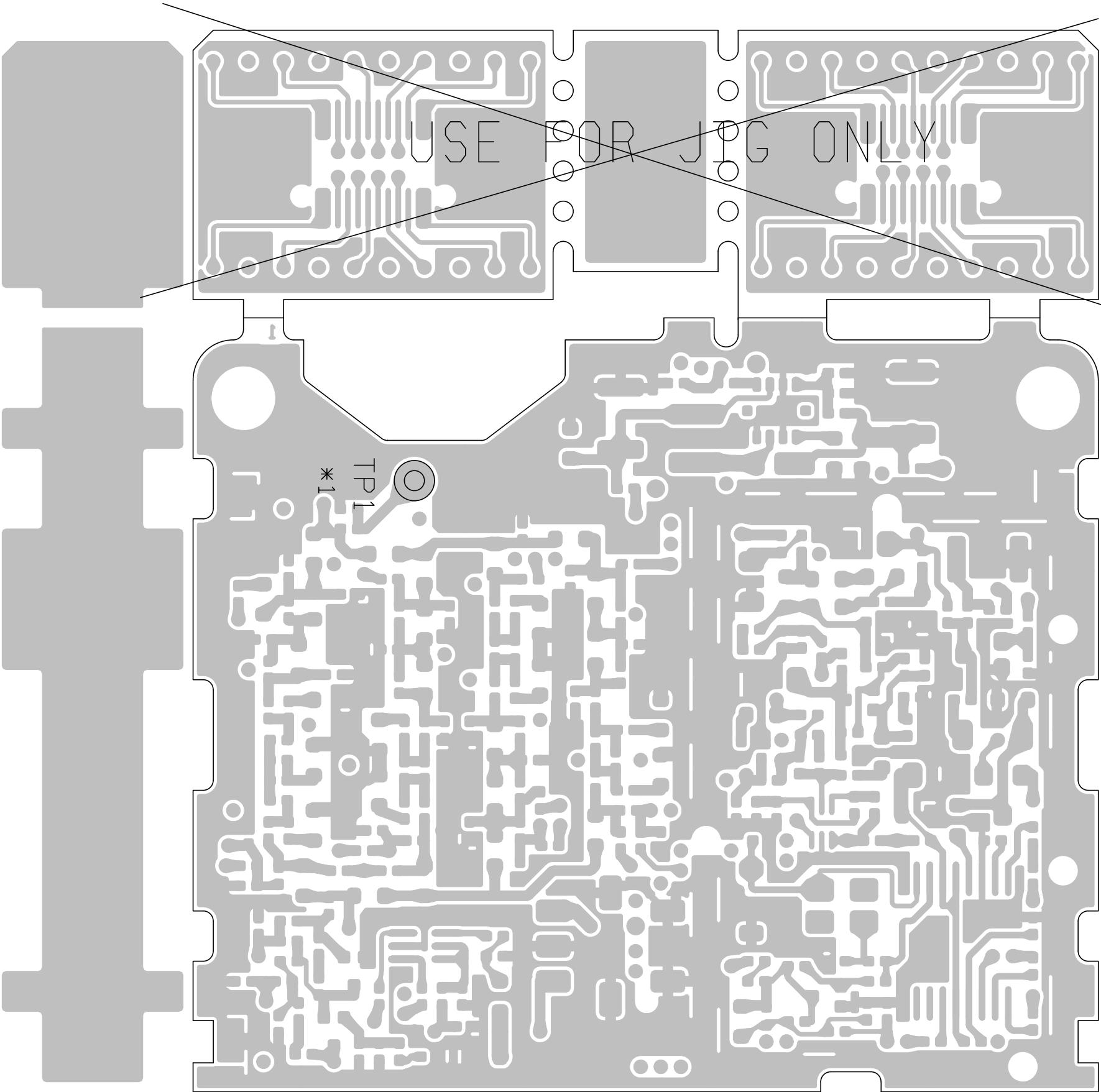
REFLECTION SHEET
RETC4C1811Z

HOLDER: DISPLAY
GHDZ4C1751Z

PCB

DESIGN. BY	DRAWN. BY	UNIDEN NO.	MODEL NO.
2011JAN17	2011JAN20	UB366Z	EZ130XLT
KODR	KODR	TITLE KEY ASS'Y	
CHECK. BY	APPRO. BY	CHIP LAYOUT BOTTOM VIEW(1/2)	
2011JAN20	2011JAN21	DRAWING NO.	E23-30585
YMATSUDA	IGA		
REV. NO.			UNIDEN CORP.

B001 PH-338AA 1/2C(BOTTOM VIEW)



Use Pb free Solder

FILM	ASSY	PCB No.	UNI No.
TOP PATTERN	MAIN ASSY	PH-338AA 1/2S	UB366Z

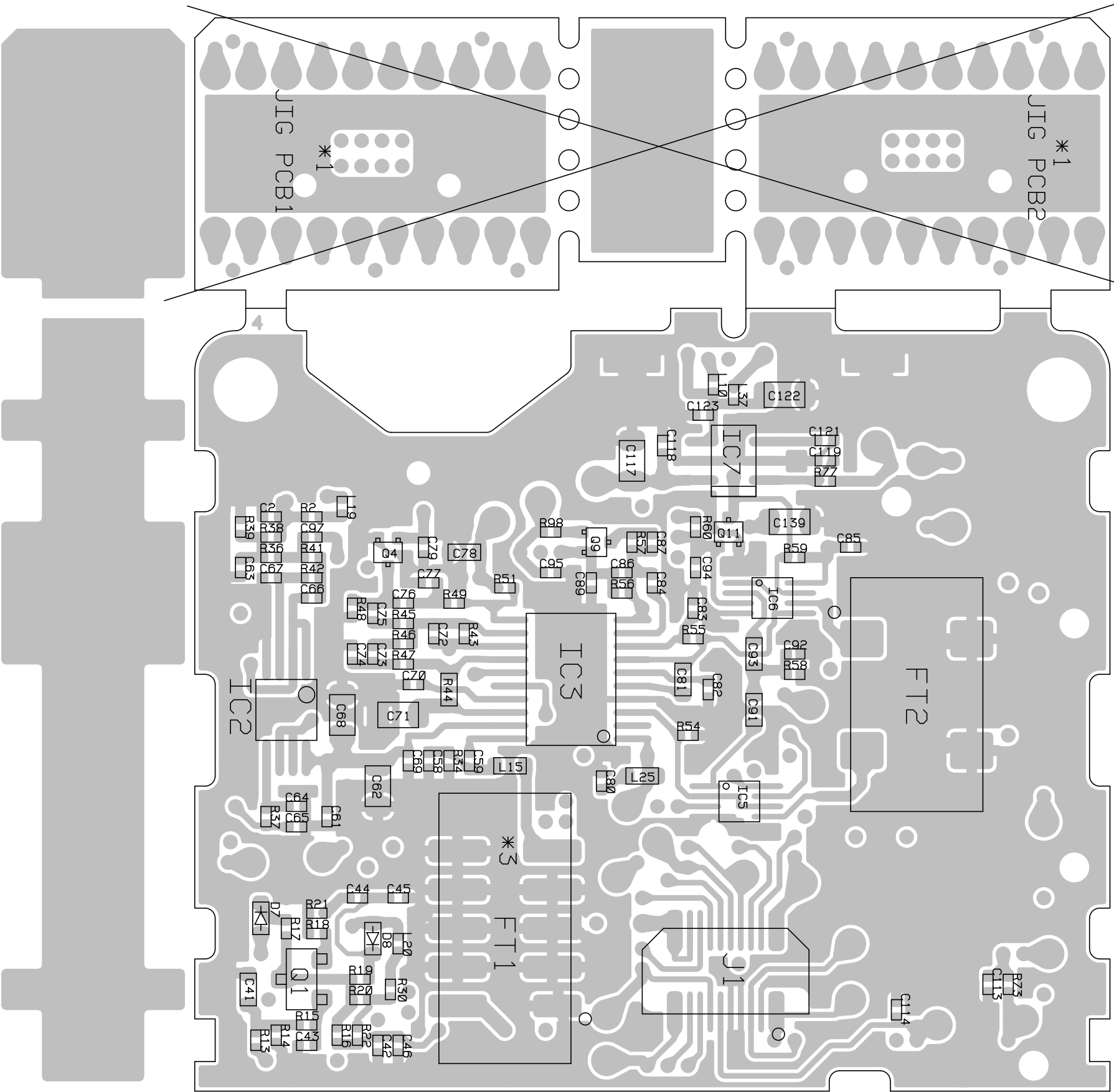
TP1 TP-0137

*1: MANUAL SOLDERING

DESIGN. BY	DRAWN. BY	UNIDEN NO.	MODEL NO.
2010OCT20	2011JUN20	UB366Z	EZ130XLT
KODR	KODR	TITLE MAIN ASS'Y	
CHECK. BY	APPRO. BY	PARTS ASS'Y BOTTOM VIEW	
2011JUN20	2011JUN21	DRAWING NO.	
YMATSUDA	IGA	E23-30582	
REV. NO.		UNIDEN CORP.	

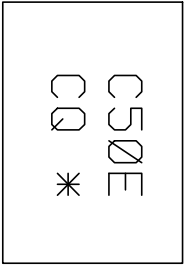
Use Pb free Solder

B001 PH-338AA 1/2(BOTTOM VIEW)

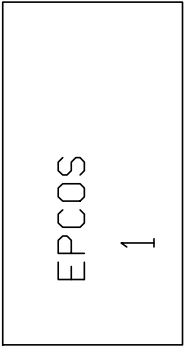


UNI No.	UB366Z		
PCB No.	PH-338AA 1/2		
ASSY	MAIN ASS'Y		
FILM	BOTTOM PATTERN		

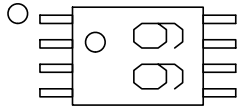
※2: FT2



※3: FT1



IC5, IC6



※1: JIG PCB

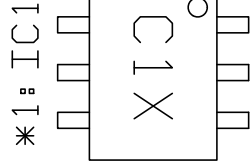
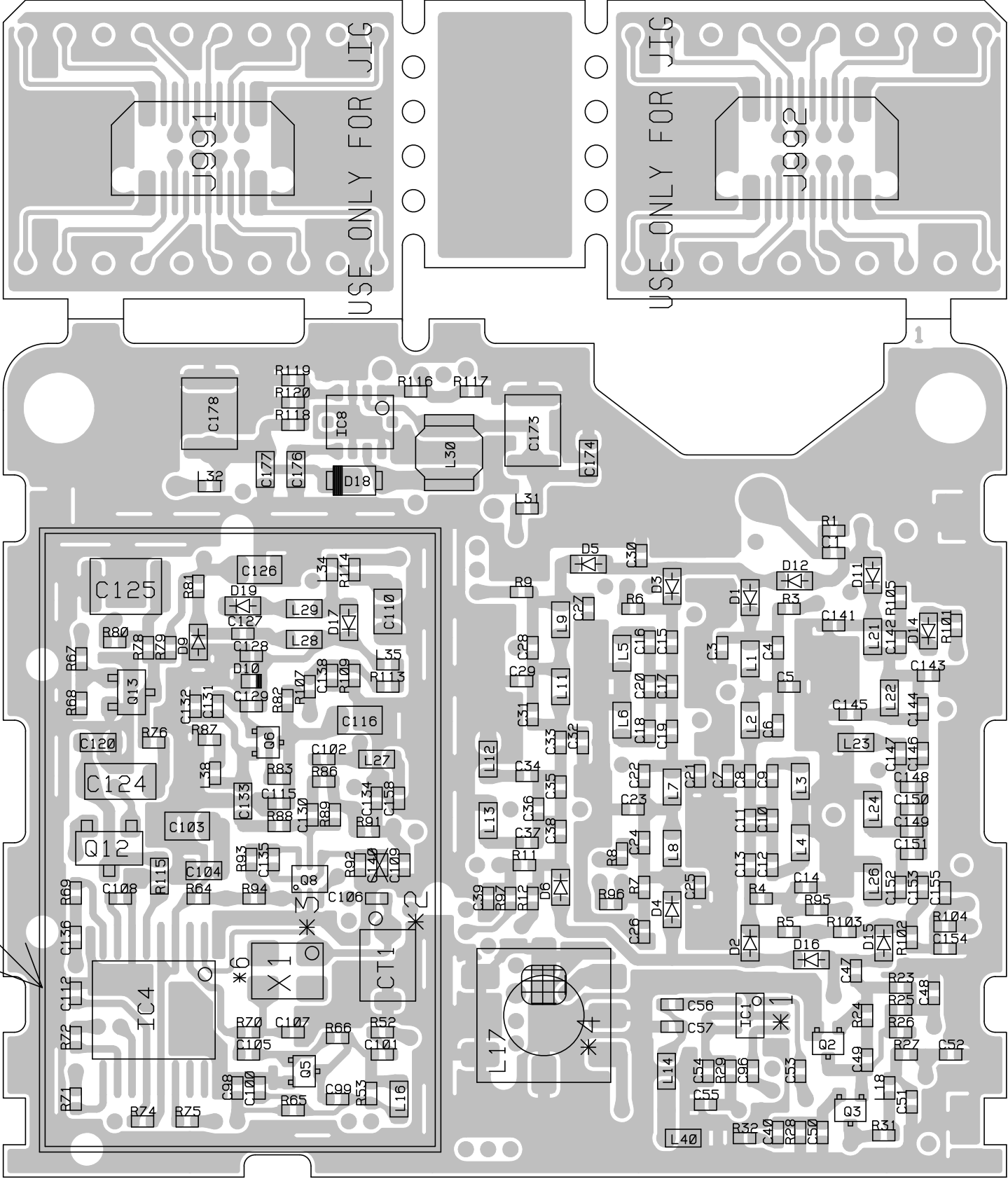
JIG PCB1 AND 2 AER
ONLY FOR MAKING THE JIG.
IT IS NOT NEEDED
ACTUAL PRODUCTION.

DESIGN. BY	DRAWN. BY	UNIDEN NO.	MODEL NO.
2010CT20	2011JAN20	UB366Z	EZ130XL1
KODR	KODR	TITLE MAIN ASS'Y	
CHECK. BY	APPRO. BY	CHIP LAYOUT BOTTOM VIEW(1/2)	
2011JAN20	2011JAN21	DRAWING NO.	
YMATSUDA	IGA	E23-30580	
REV.	NO.	UNIDEN CORP.	

Use Pb free Solder

*5: SHIELD CASE: HSDC4F3250Z(REFLOW)

B001 PH-338AA 1/2(TOP VIEW)

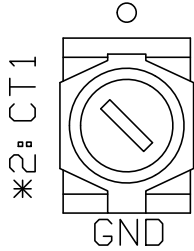


*6: X1

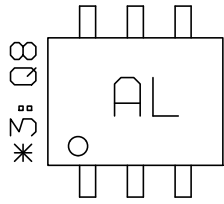
23.500
TEW

or

23.500
TEW



*2: CT1



*3: Q8

*4: NJ LOCK GREEN AFTER ADJ.
THREE BOND 1401B
ZABD7002002

*5: SHIELD CASE IS REFLOW SOLDERING.

DESIGN. BY	DRAWN. BY	UNIDEN NO.	MODEL NO.
2011JAN17	2011JAN20	UB366Z	EZ130XLT
KODA	KODA	TITLE	MAIN ASS'Y
CHECK. BY	APPRO. BY	CHIP LAYOUT TOP VIEW(1/2)	
2011JAN20	2011JAN21	DRAWING NO.	E23-30578
YMATSUDA	IGA		
REV. NO.			UNIDEN CORP.

